



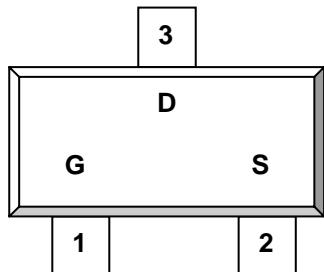
ST2301A 
P Channel Enhancement Mode MOSFET

-3.0A

DESCRIPTION

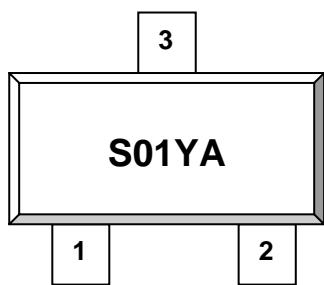
ST2301A is the P-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management, other battery powered circuits, and low in-line power loss are required. The product is in a very small outline surface mount package.

PIN CONFIGURATION SOT-23

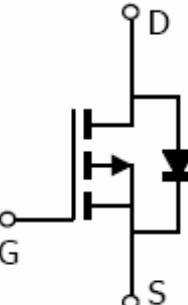


1.Gate 2.Source 3.Drain

PART MARKING SOT-23



Y: Year Code A: Process Code



ORDERING INFORMATION

Part Number	Package	Part Marking
ST2301SRG	SOT-23	S01YA

* Process Code : A ~ Z ; a ~ z

* ST2301SRG : S : SOT23 R : Tape Reel ; G : Pb - Free

STANSON TECHNOLOGY
120 Bentley Square, Mountain View, Ca 94040 USA
www.stansontech.com



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ABSOULTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-20	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current (T _J =150°C)	T _A =25°C T _A =70°C	I _D -3.0 -2.0	A
Pulsed Drain Current	I _{DM}	-10	A
Continuous Source Current (Diode Conduction)	I _S	-1.6	A
Power Dissipation	T _A =25°C T _A =70°C	P _D 1.25 0.8	W
Operation Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	120	°C/W



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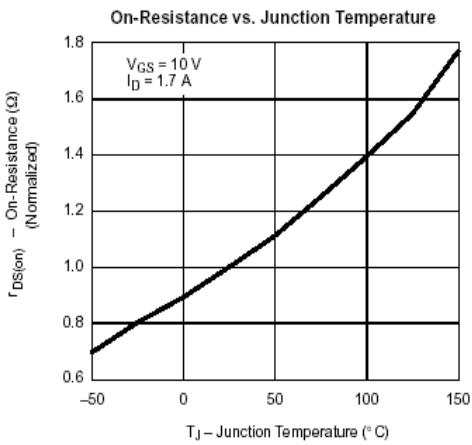
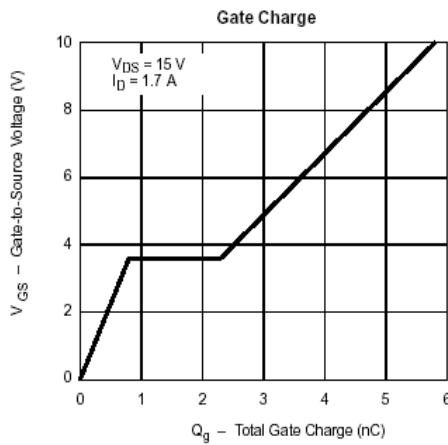
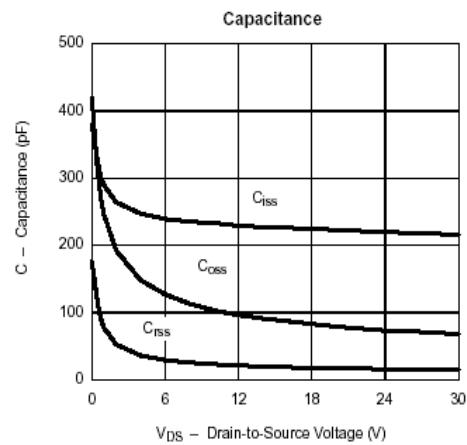
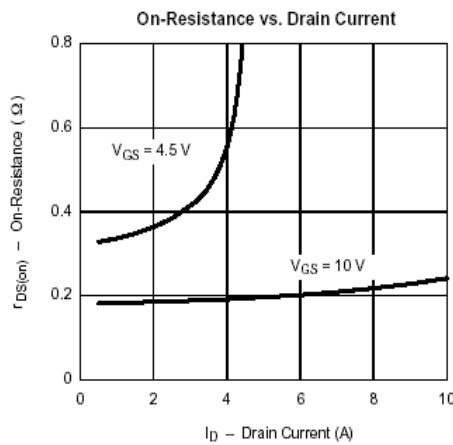
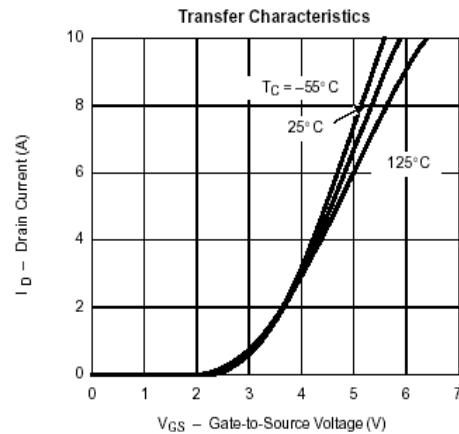
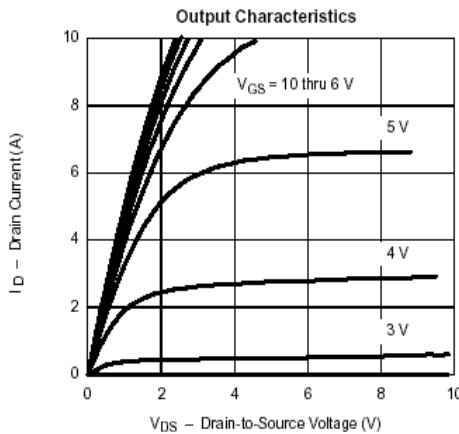
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ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250uA	-20			V	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250uA	-0.45		-1.5	V	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V			-1	uA	
		V _{DS} =-20V, V _{GS} =0V T _J =55°C			-10		
On-State Drain Current	I _{D(on)}	V _{DS} ≤-5V, V _{GS} =-4.5V V _{DS} ≤-5V, V _{GS} =-2.5V	-6 -3			A	
Drain-source On-Resistance	R _{D(on)}	V _{GS} =-2.5V, I _D =-2.0A V _{GS} =-4.5V, I _D =-2.8A		0.080 0.120		Ω	
Forward Transconductance	g _{fs}	V _{DS} =-5V, I _D =-2.8V		6.5		S	
Diode Forward Voltage	V _{SD}	I _S =-1.6A, V _{GS} =0V		-0.8	-1.2	V	
Dynamic							
Total Gate Charge	Q _g	V _{DS} =-6V V _{GS} =-4.5V I _D ≡-2.8A		5.8	10	nC	
Gate-Source Charge	Q _{gs}			0.85			
Gate-Drain Charge	Q _{gd}			1.7			
Input Capacitance	C _{iss}	V _{DS} =-6V V _{GS} =0V F=1MHz		415		pF	
Output Capacitance	C _{oss}			223			
Reverse Transfer Capacitance	C _{rss}			87			
Turn-On Time	t _{d(on)} tr	V _{DD} =-6V R _L =6Ω I _D =-1A V _{GEN} =-4.5V R _G =6Ω		13	25	nS	
				36	60		
Turn-Off Time	t _{d(off)} tf			42	70		
				34	60		

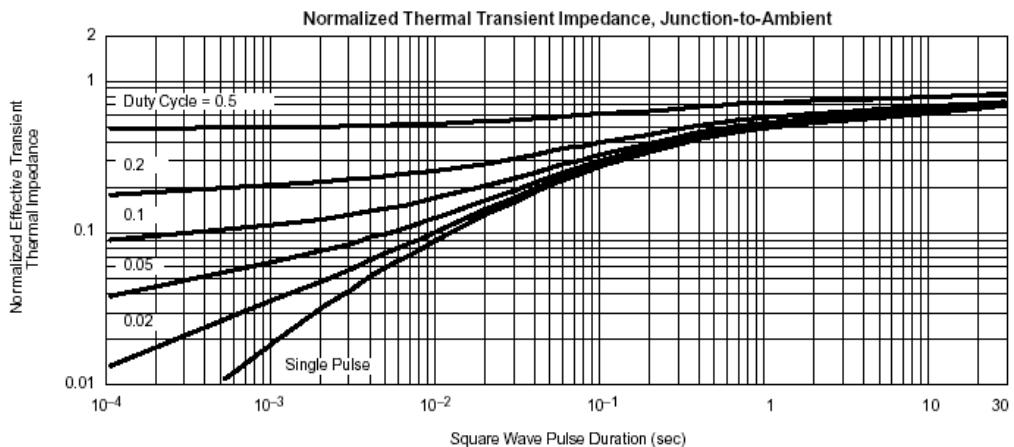
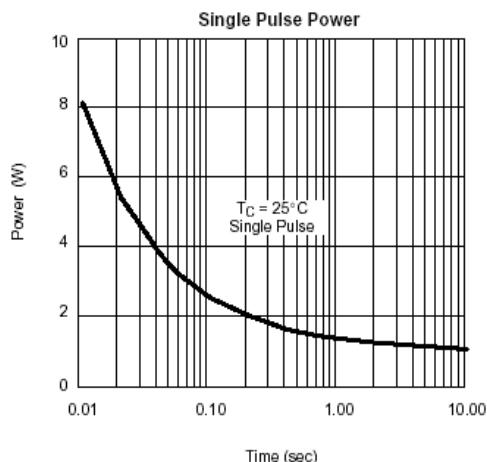
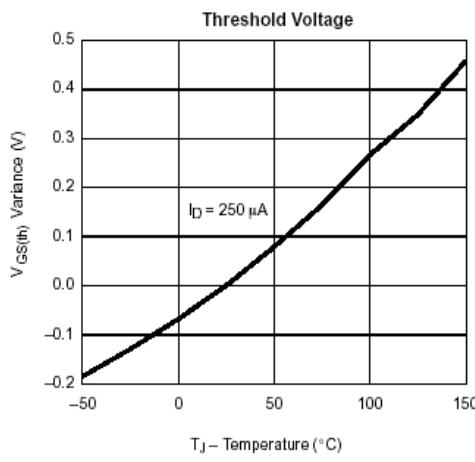
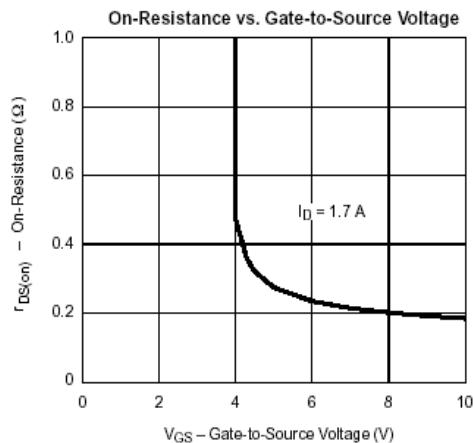
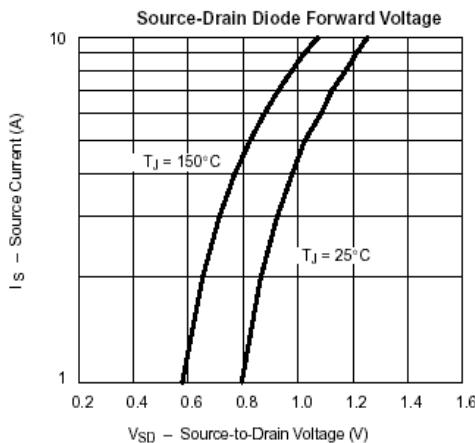
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TYPICAL CHARACTERISTICS (25°C Unless noted)



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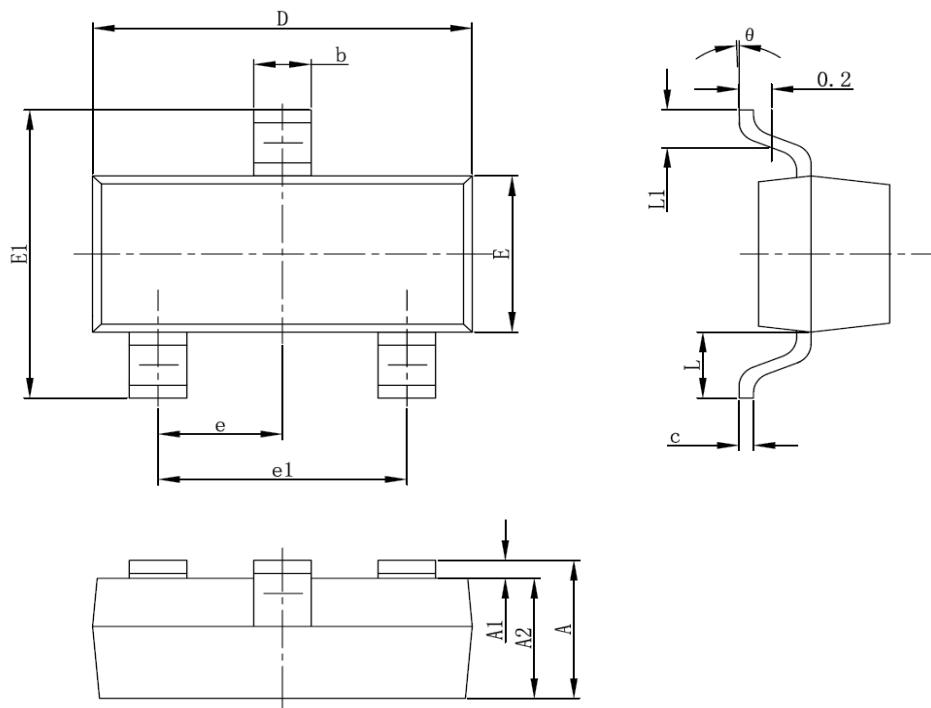




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SOT-23 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

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